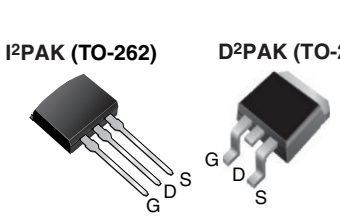
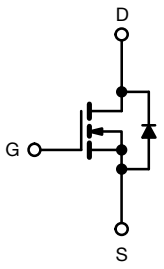
## Power MOSFET




N-Channel MOSFET

### FEATURES

- Surface-mount (IRFBC20S, SiHFBC20S)
- Low-profile through-hole (IRFBC20L, SiHFBC20L)
- Available in tape and reel (IRFBC20, SiiHFBC20S)
- Dynamic dV/dt rating
- 150 °C operating temperature
- Fast switching
- Fully avalanche rated
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS* Available

HALOGEN FREE Available

**Note**

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

| PRODUCT SUMMARY | | |
|---|---|---|
| $V_{DS}$ (V) | 600 | |
| $R_{DS(on)}$ (Ω) | $V_{GS}$ = 10 V | 4.4 |
| $Q_g$ max. (nC) | 18 | |
| $Q_{gs}$ (nC) | 3.0 | |
| $Q_{gd}$ (nC) | 8.9 | |
| Configuration | Single | |

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK is a surface-mount power package capable of the accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface-mount package. The D²PAK is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface-mount application. The through-hole version (IRFBC20L, SiHFBC20L) is a available for low-profile applications.

| ORDERING INFORMATION | | | |
|---|---|---|---|
| Package | D²PAK (TO-263) | D²PAK (TO-263) | I²PAK (TO-262) |
| Lead (Pb)-free and halogen-free | SiHFBC20S-GE3 | SiHFBC20STRL-GE3 [a] | SiHFBC20L-GE3 |
| Lead (Pb)-free | IRFBC20SPbF | IRFBC20STRLPbF [a] | |

**Note**

a. See device orientation

| ABSOLUTE MAXIMUM RATINGS ($T_C$ = 25 °C, unless otherwise noted) | | | | | |
|---|---|---|---|---|---|
| **PARAMETER** | | | **SYMBOL** | **LIMIT** | **UNIT** |
| Drain-source voltage | | | $V_{DS}$ | 600 | V |
| Gate-source voltage | | | $V_{GS}$ | ± 20 | |
| Continuous drain current [e] | $V_{GS}$ at 10 V | $T_C$ = 25 °C | $I_D$ | 2.2 | A |
| | | $T_C$ = 100 °C | | 1.4 | |
| Pulsed drain current [a, e] | | | $I_{DM}$ | 8.0 | |
| Linear derating factor | | | | 0.40 | W/°C |
| Single pulse avalanche energy [b, e] | | | $E_{AS}$ | 84 | mJ |
| Avalanche current a | | | $I_{AR}$ | 2.2 | A |
| Repetiitive avalanche energy [a] | | | $E_{AR}$ | 5.0 | mJ |
| Maximum power dissipation | $T_A$ = 25 °C | | $P_D$ | 3.1 | W |
| | $T_C$ = 25 °C | | | 50 | |
| Peak diode recovery dv/dt [c, e] | | | dv/dt | 3.0 | V/ns |
| Operating junction and storage temperature range | | | $T_J$, $T_{stg}$ | -55 to +150 | °C |
| Soldering recommendations (peak temperature) [d] | for 10 s | | | 300 | |

**Notes**

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
b. $V_{DD}$ = 50 V, starting $T_J$ = 25 °C, L = 31 mH, $R_g$ = 25 Ω, $I_{AS}$ = 2.2 A (see fig. 12)
c. $I_{SD} \leq$ 2.2 A, dI/dt ≤ 40 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq$ 150 °C
d. 1.6 mm from case
e. Uses IRFBC20, SiHFBC20 data and test conditions



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| THERMAL RESISTANCE RATINGS | | | | |
|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TYP.** | **MAX.** | **UNIT** |
| Maximum junction-to-ambient (PCB mounted, steady-state) [a] | $R_{thJA}$ | - | 40 | °C/W |
| Maximum junction-to-case (drain) | $R_{thJC}$ | - | 2.5 | |

**Note**

a. When mounted on 1" square PCB (FR-4 or G-10 material)

| **SPECIFICATIONS** ($T_J$ = 25 °C, unless otherwise noted) | | | | | | |
|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | **MIN.** | **TYP.** | **MAX.** | **UNIT** |
| **Static** | | | | | | |
| Drain-source breakdown voltage | $V_{DS}$ | $V_{GS}$ = 0, $I_D$ = 250 µA | 600 | - | - | V |
| $V_{DS}$ temperature coefficient | $\Delta V_{DS}/T_J$ | Reference to 25 °C, $I_D$ = 1 mA [c] | - | 0.88 | - | V/°C |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | 2.0 | - | 4.0 | V |
| Gate-source leakage | $I_{GSS}$ | $V_{GS}$ = ± 20 V | - | - | ± 100 | nA |
| Zero gate voltage drain current | $I_{DSS}$ | $V_{DS}$ = 600 V, $V_{GS}$ = 0 V | - | - | 100 | µA |
| | | $V_{DS}$ = 480 V, $V_{GS}$ = 0 V, $T_J$ = 125 °C | - | - | 500 | |
| Drain-source on-state resistance | $R_{DS(on)}$ | $V_{GS}$ = 10 V, $I_D$ = 1.3 A [b] | - | - | 4.4 | Ω |
| Forward transconductance | $g_{fs}$ | $V_{DS}$ = 50 V, $I_D$ = 1.3 A [c] | 1.4 | - | - | S |
| **Dynamic** | | | | | | |
| Input capacitance | $C_{iss}$ | $V_{GS}$ = 0 V, $V_{DS}$ = 25 V, f = 1.0 MHz, see fig. 5 [c] | - | 350 | - | pF |
| Output capacitance | $C_{oss}$ | | - | 48 | - | |
| Reverse transfer capacitance | $C_{rss}$ | | - | 8.6 | - | |
| Total gate charge | $Q_g$ | $V_{GS}$ = 10 V, $I_D$ = 2.0 A, $V_{DS}$ = 360 V, see fig. 6 and 13 [b, c] | - | - | 18 | nC |
| Gate-source charge | $Q_{gs}$ | | - | - | 3.0 | |
| Gate-drain charge | $Q_{gd}$ | | - | - | 8.9 | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD}$ = 300 V, $I_D$ = 2.0 A, $R_g$ = 18 Ω, $R_D$ = 150 Ω, see fig. 10 [b, c] | - | 10 | - | ns |
| Rise time | $t_r$ | | - | 23 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 30 | - | |
| Fall time | $t_f$ | | - | 25 | - | |
| Gate input resistance | $R_g$ | f = 1 MHz, open drain | 1.2 | - | 7.4 | Ω |
| Internal source inductance | $L_S$ | Between lead, and center of die contact | - | 7.5 | - | nH |
| **Drain-Source Body Diode Characteristics** | | | | | | |
| Continuous source-drain diode current | $I_S$ | MOSFET symbol showing the integral reverse p - n junction diode  | - | - | 2.2 | A |
| Pulsed diode forward current [a] | $I_{SM}$ | | - | - | 8.0 | |
| Body diode voltage | $V_{SD}$ | $T_J$ = 25 °C, $I_S$ = 2.2 A, $V_{GS}$ = 0 V [b] | - | - | 1.6 | V |
| Body diode reverse recovery time | $t_{rr}$ | $T_J$ = 25 °C, $I_F$ = 2.0 A, dI/dt = 100 A/µs [b, c] | - | 290 | 580 | ns |
| Body diode reverse recovery charge | $Q_{rr}$ | | - | 0.67 | 1.3 | µC |
| Forward turn-on time | $t_{on}$ | Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$) | | | | |

**Notes**

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
b. Pulse width ≤ 300 µs; duty cycle ≤ 2 %
c. Uses IRFBC20, SiHFBC20 data and test conditions


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**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

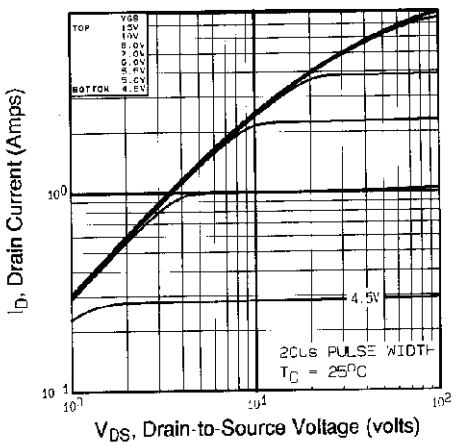



**Fig. 1 - Typical Output Characteristics, $T_C$ = 25 °C**

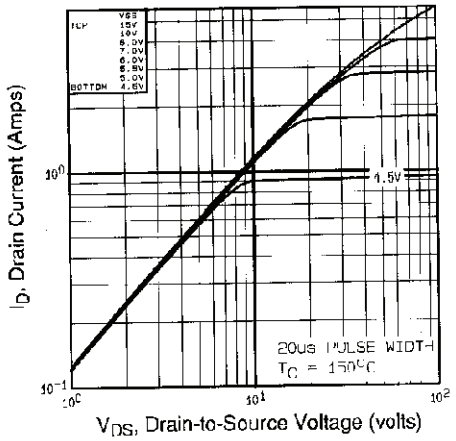



**Fig. 2 - Typical Output Characteristics, $T_C$ = 150 °C**

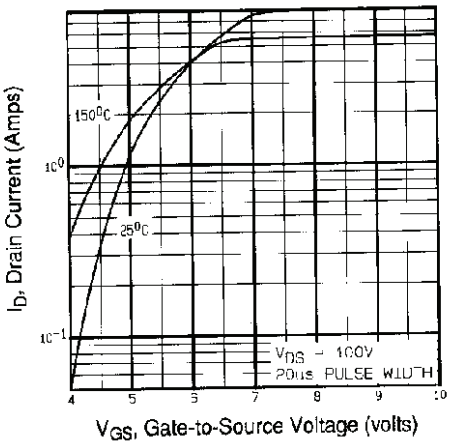



**Fig. 3 - Typical Transfer Characteristics**

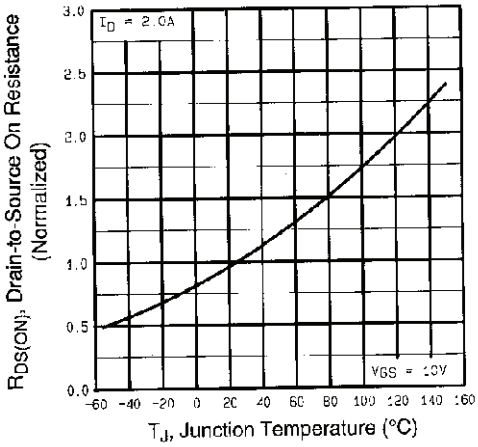



**Fig. 4 - Normalized On-Resistance vs. Temperature**

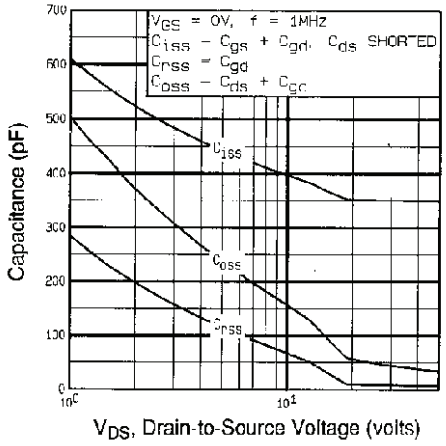



**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

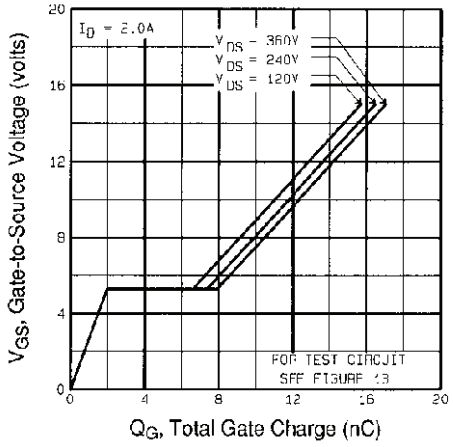



**Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage**


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**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

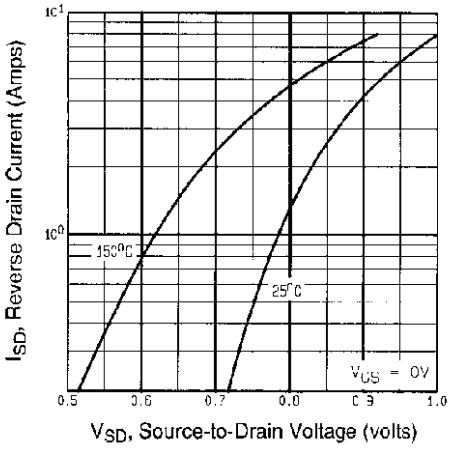



**Fig. 7 - Typical Source-Drain Diode Forward Voltage**

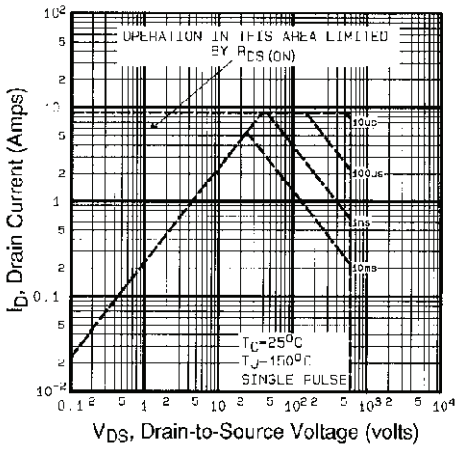



**Fig. 8 - Maximum Safe Operating Area**

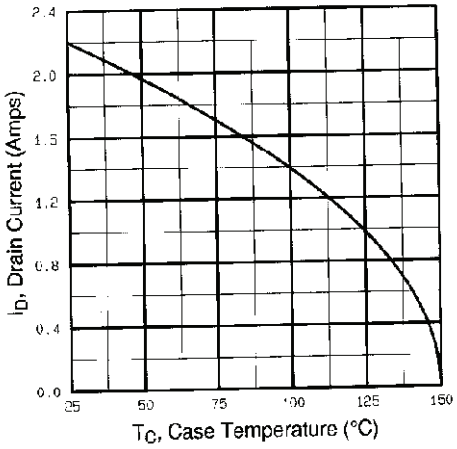



**Fig. 9 - Maximum Drain Current vs. Case Temperature**

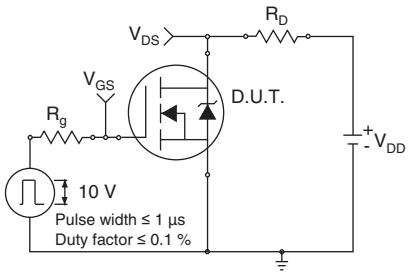



**Fig. 10a - Switching Time Test Circuit**

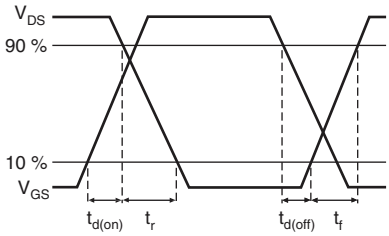



**Fig. 10b - Switching Time Waveforms**


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**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

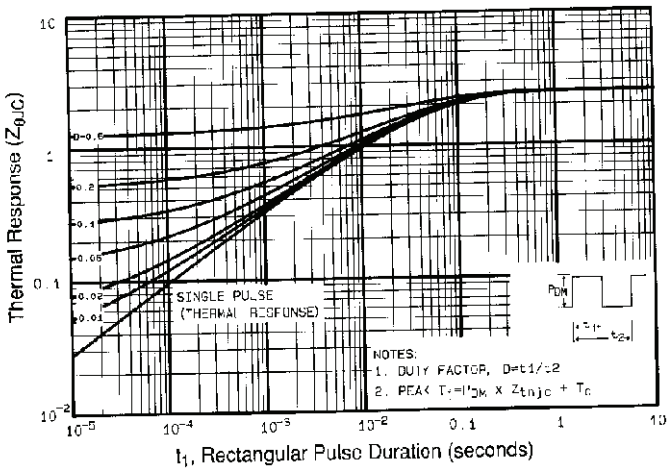



**Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**

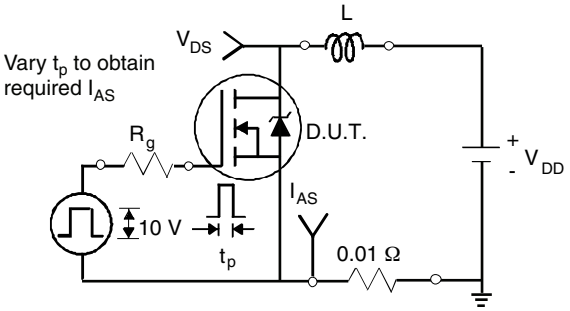



**Fig. 12a - Unclamped Inductive Test Circuit**

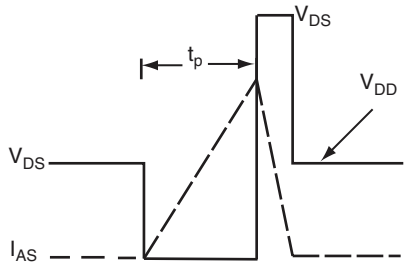



**Fig. 12b - Unclamped Inductive Waveforms**

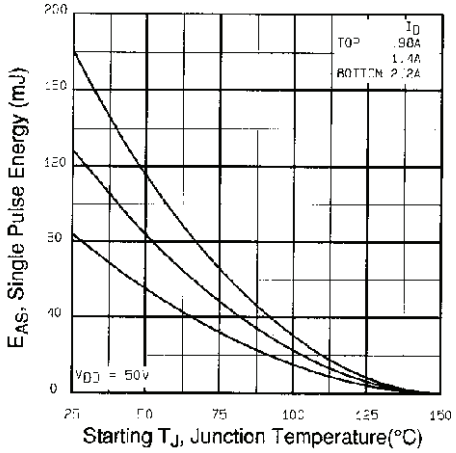



**Fig. 12c - Maximum Avalanche Energy vs. Drain Current**


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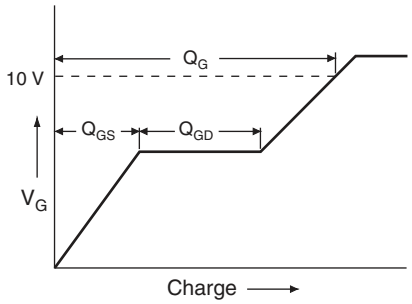



**Fig. 13a - Maximum Avalanche Energy vs. Drain Current**

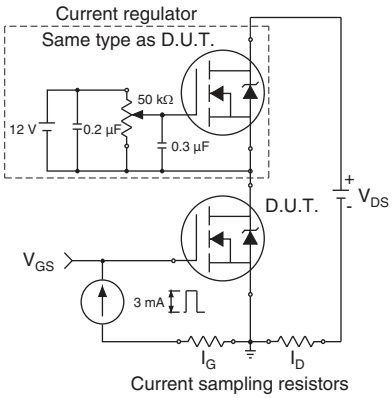
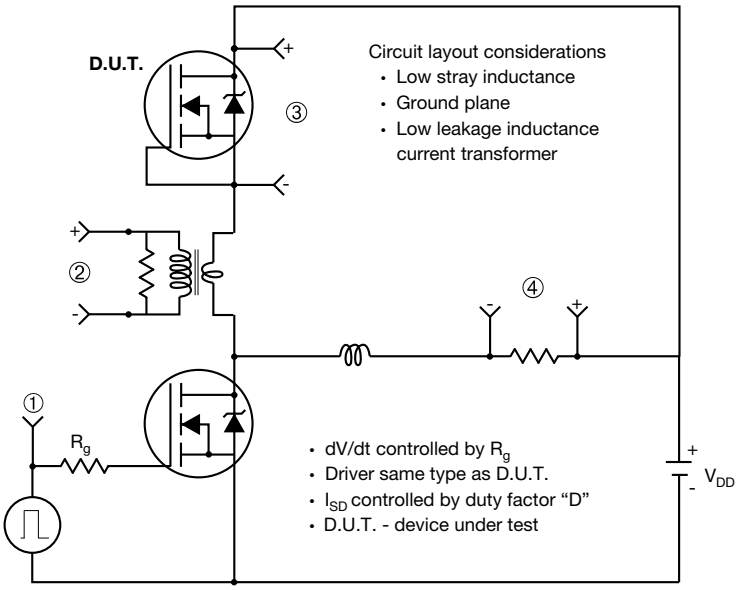
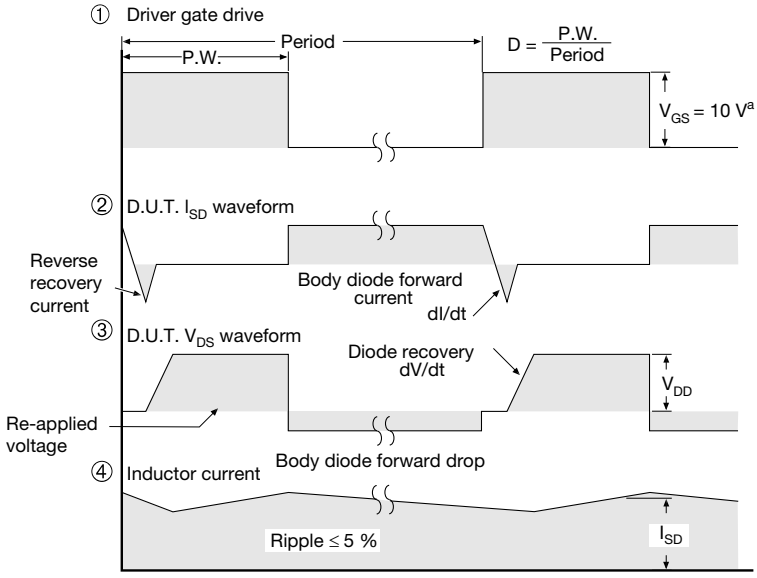



**Fig. 13b - Gate Charge Test Circuit**


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**Peak Diode Recovery dV/dt Test Circuit**




**Note**

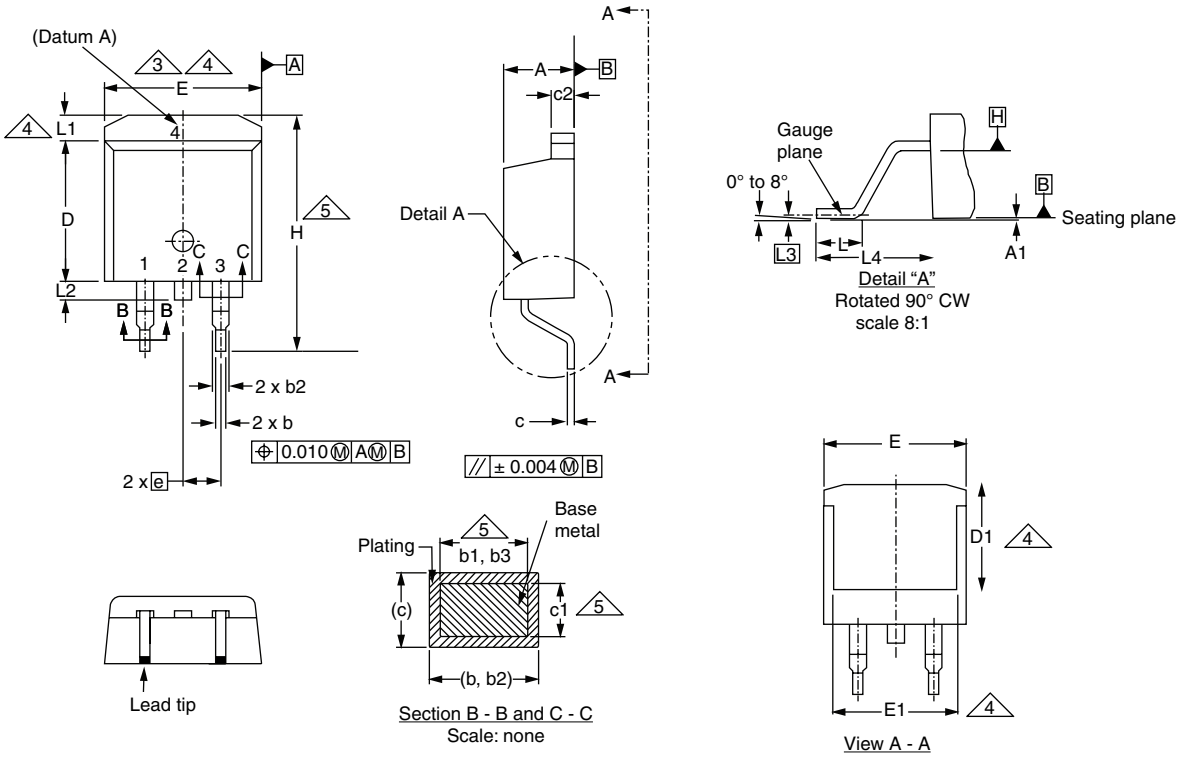
a. $V_{GS}$ = 5 V for logic level devices

**Fig. 14 - For N-Channel**



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## TO-263AB (HIGH VOLTAGE)




| | MILLIMETERS | | INCHES | |
|---|---|---|---|---|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| A | 4.06 | 4.83 | 0.160 | 0.190 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 |
| b | 0.51 | 0.99 | 0.020 | 0.039 |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 |
| c | 0.38 | 0.74 | 0.015 | 0.029 |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 |
| D | 8.38 | 9.65 | 0.330 | 0.380 |

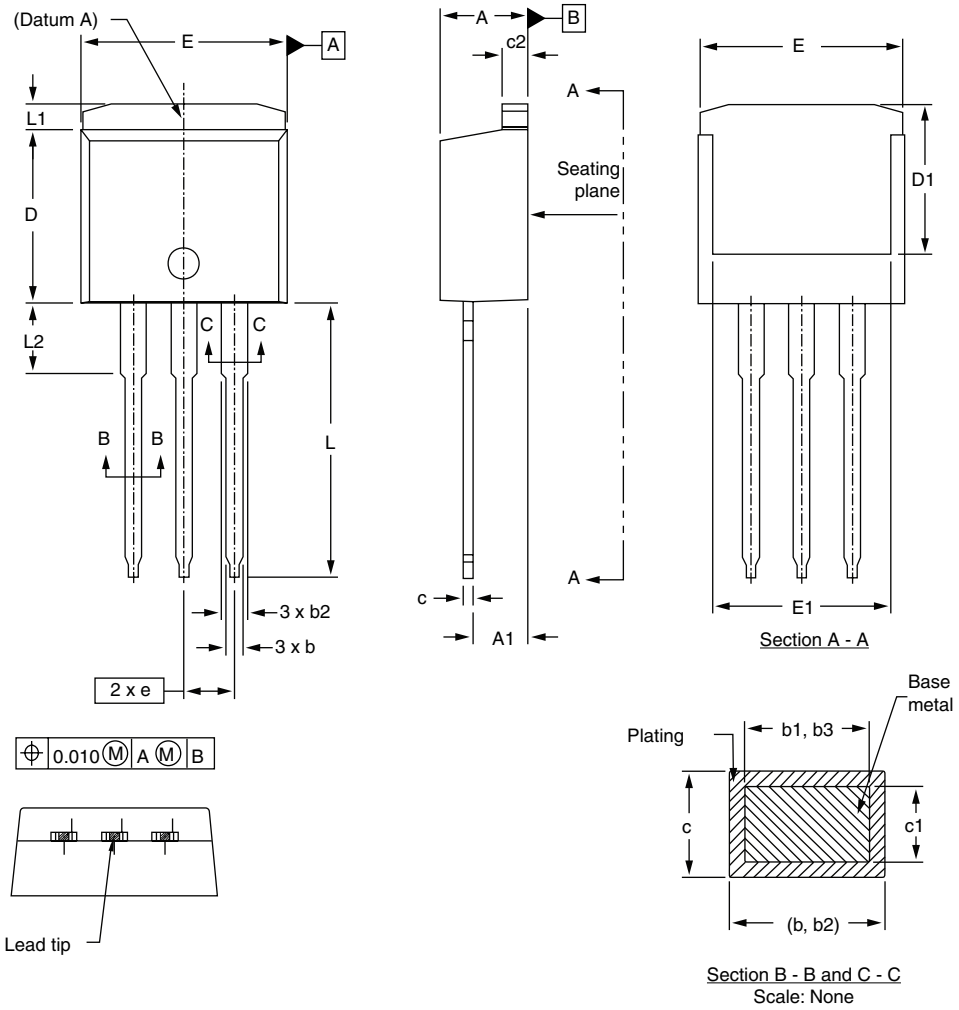
| | MILLIMETERS | | INCHES | |
|---|---|---|---|---|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| D1 | 6.86 | - | 0.270 | - |
| E | 9.65 | 10.67 | 0.380 | 0.420 |
| E1 | 6.22 | - | 0.245 | - |
| e | 2.54 BSC | | 0.100 BSC | |
| H | 14.61 | 15.88 | 0.575 | 0.625 |
| L | 1.78 | 2.79 | 0.070 | 0.110 |
| L1 | - | 1.65 | - | 0.066 |
| L2 | - | 1.78 | - | 0.070 |
| L3 | 0.25 BSC | | 0.010 BSC | |
| L4 | 4.78 | 5.28 | 0.188 | 0.208 |

ECN: S-82110-Rev. A, 15-Sep-08
DWG: 5970

**Notes**

1. Dimensioning and tolerancing per ASME Y14.5M-1994.
2. Dimensions are shown in millimeters (inches).
3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
5. Dimension b1 and c1 apply to base metal only.
6. Datum A and B to be determined at datum plane H.
7. Outline conforms to JEDEC outline to TO-263AB.

## I²PAK (TO-262) (HIGH VOLTAGE)




| | MILLIMETERS | | INCHES | |
|---|---|---|---|---|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| A | 4.06 | 4.83 | 0.160 | 0.190 |
| A1 | 2.03 | 3.02 | 0.080 | 0.119 |
| b | 0.51 | 0.99 | 0.020 | 0.039 |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 |
| c | 0.38 | 0.74 | 0.015 | 0.029 |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 |

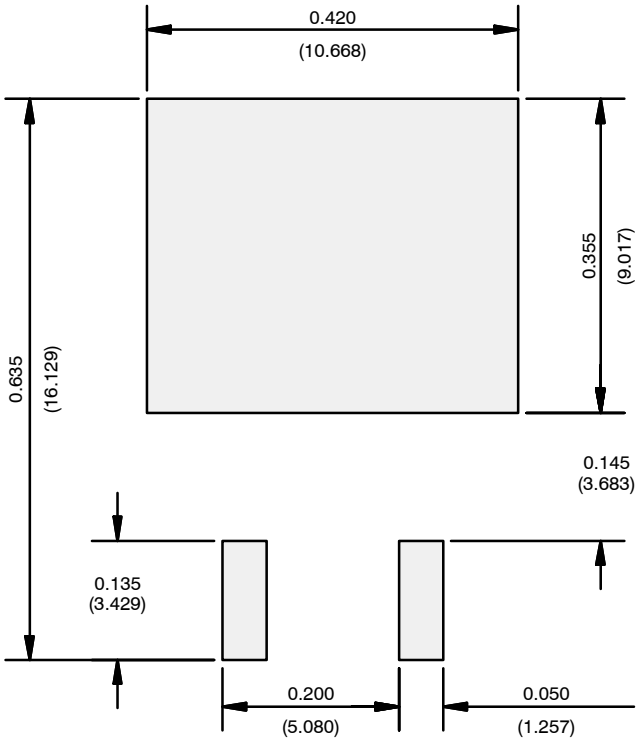
| | MILLIMETERS | | INCHES | |
|---|---|---|---|---|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| D | 8.38 | 9.65 | 0.330 | 0.380 |
| D1 | 6.86 | - | 0.270 | - |
| E | 9.65 | 10.67 | 0.380 | 0.420 |
| E1 | 6.22 | - | 0.245 | - |
| e | 2.54 BSC | | 0.100 BSC | |
| L | 13.46 | 14.10 | 0.530 | 0.555 |
| L1 | - | 1.65 | - | 0.065 |
| L2 | 3.56 | 3.71 | 0.140 | 0.146 |

ECN: S-82442-Rev. A, 27-Oct-08
DWG: 5977

**Notes**

1. Dimensioning and tolerancing per ASME Y14.5M-1994.
2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outmost extremes of the plastic body.
3. Thermal pad contour optional within dimension E, L1, D1, and E1.
4. Dimension b1 and c1 apply to base metal only.

## RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead




Recommended Minimum Pads
Dimensions in Inches/(mm)

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